

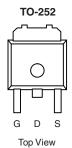
N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A) ^a			
60	0.025 at V _{GS} = 10 V	45			
	$0.030 \text{ at V}_{GS} = 4.5 \text{ V}$	40			

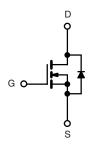
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature





Drain Connected to Tab



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Gate-Source Voltage		V _{GS}	± 20	V		
Outiness Paris Outer (T. 175 co)h	T _C = 25 °C	I-	45			
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C	- I _D	35			
Pulsed Drain Current	I _{DM}	100	Α			
Continuous Source Current (Diode Conduction)	I _S	23				
Avalanche Current	I _{AS}	20	1			
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	20	mJ		
Marianum Davier Dissination	T _C = 25 °C	В	100	w		
Maximum Power Dissipation	T _A = 25 °C	P _D	3 ^a			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	- R _{thJA}	18	22	°C/W		
Maximum Junction-to-Ambient	Steady State		40	50			
Maximum Junction-to-Case		R _{thJC}	3.2	4			

Notes:

a. Surface Mounted on 1" x 1" FR4 board, $t \le 10$ sec.



Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60) V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0	2.0	3.0		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 60 V, V _{GS} = 0 V	1		1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		V _{GS} = 10 V, I _D = 15 A		0.025			
	_	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.055		Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C		0.069			
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.030			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		20		S	
Dynamic ^a				•			
Input Capacitance	C _{iss}			1500		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		140			
Reverse Transfer Capacitance	C _{rss}			60		1	
Total Gate Charge ^c	Q_g			11	17		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$		3		nC	
Gate-Drain Charge ^c	Q_{gd}			3			
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 1.3 Ω		15	25		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 23$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		30	45	ns	
Fall Time ^c	t _f			25	40		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C)					
Pulsed Current	I _{SM}				50	Α	
Diode Forward Voltage	V_{SD}	$I_F = 15 \text{ A}, V_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}	$I_F = 15 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		30	60	ns	

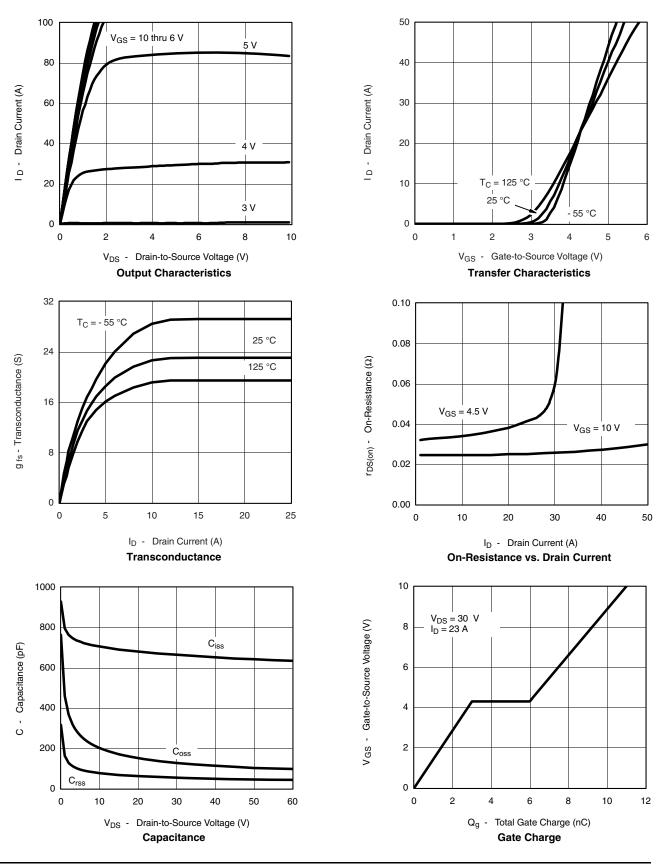
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

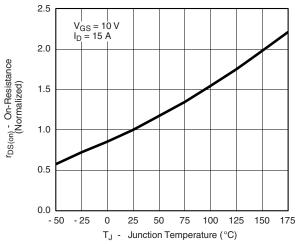


TYPICAL CHARACTERISTICS 25 °C unless noted

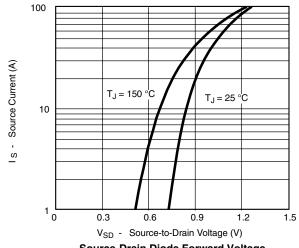




TYPICAL CHARACTERISTICS 25 °C unless noted



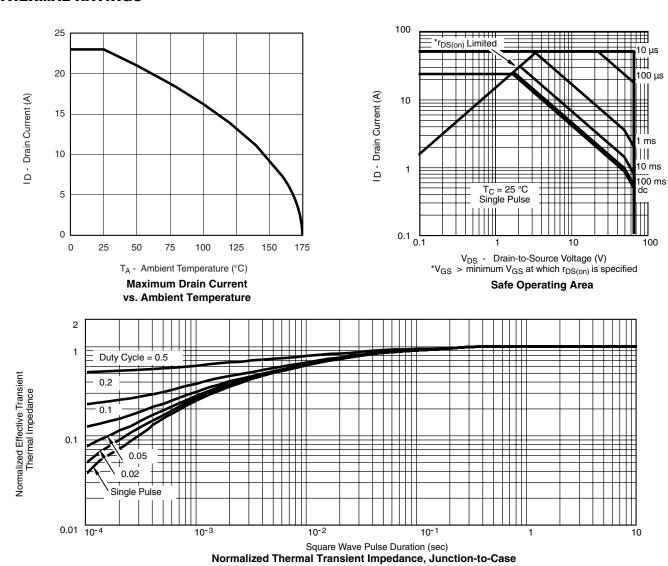
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

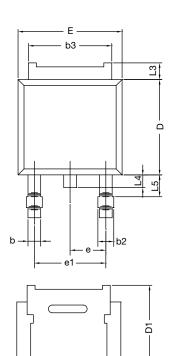


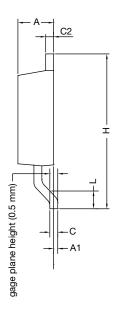
THERMAL RATINGS





TO-252AA CASE OUTLINE





	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	5.21	-	0.205	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090	BSC		
e1	4.56 BSC		0.180 BSC			
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.14	1.52	0.045	0.060		
ECN: X12-0247-Rev. M, 24-Dec-12						

DWG: 5347

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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